



CALICE SiW ECAL – Status of Prototype

Roman Pöschl









On behalf of the SiW ECAL Groups in CALICE:















TB Meeting – July 2021









1



- The stack is a priori ready
 - However at the moment only 11 fully equipped layers
 - Two more ASUs of type FEV12 have been tested electrically and wait for being equipped with
 - HV Kapton
 - One more is (still) under repair at LPNHE
 - COBs will complete the stack
 - Decided to produce two more over summer
 - For these two we have a metrology sheet and can thus follow the occurance of deformations
 - Planned trip to CERN for chip bonding in June
- Completion of the stack with the goal to run with 15 ASUs/layers
 - Setup can be completed by FEV13 (See talk by Jihane in September meeting and next slide)
 - Would need (additional) mechanical housing
- Continuous commissioning in coming weeks with progressive increase of number of layers
 - Manpower situation has improved (New PhD and intern at IJCLab + Visit of Adrian to IJCLab)
- Setup of proper interlock and slow control systems for beam test







- Mounting of stack in 2nd half of may
 - ... including two slabs repaired at LPNHE over Winter/Spring 2020/21
- Start on 2nd of June with 15 layers by Yuichi (PhD), Robin (intern), IJCLab engineers and technicians and Adrian during visit to IJCLab
 - Reminder: 15 layers correspond to 15360 cells



- Since 2/6/21: Commissioning
- Since 18/6/21: Data taking with cosmics







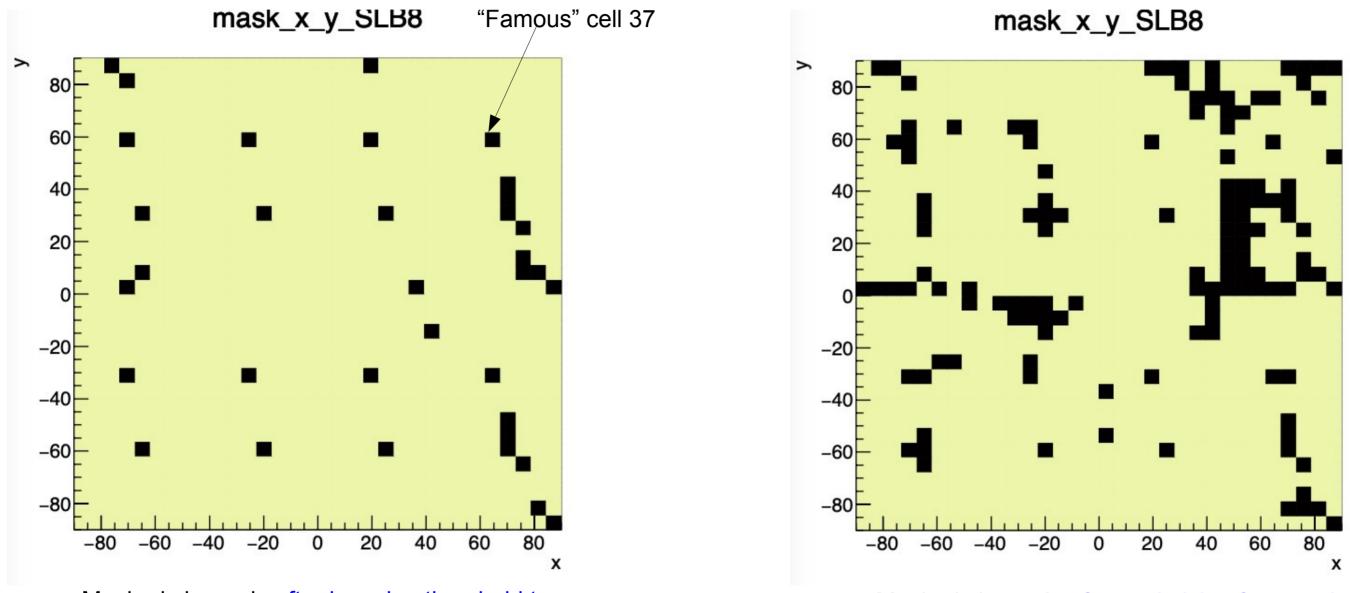
- Commissioning using scripts and s/w developed by Adrian in recent years (available on github)
- Four long cosmic runs since 18/6/21 (taken by Yuichi under guidance by Adrian)
 - 50001 50004
 - Consistent settings since 25/6/21
 - Report on data taking via e-mail and via elog hosted at LLR
 - Data stored in Ecal-Box at CERN and are accessible to Ecal members
 - Currently analysis is mainly carried out by Adrian and Yuichi but hope to increase circle of analysers in coming weeks/months
- Regular DQ Meetings





Impression Commissioning I

Typical slab: SlabID 21 (currently layer 8)



- Masked channels after lowering threshold to 275 DAC (~3/4 MIP)
- Short acquisition window 1ms
- Less vulnerable to noise and in particular to retriggering

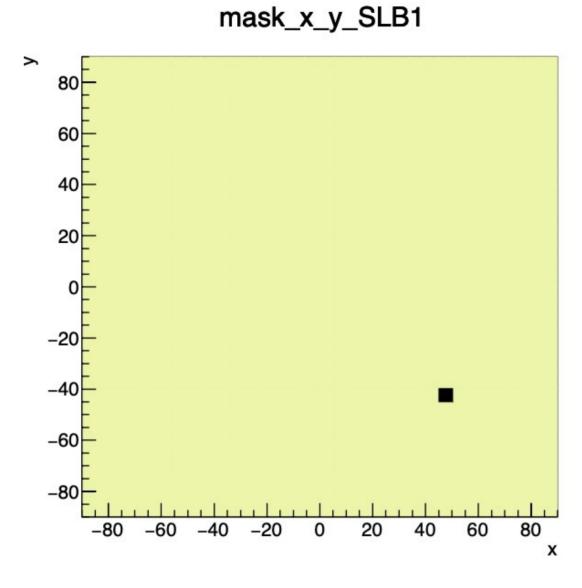
- Masked channels after optimising for cosmics
- Long acquisition window 100ms
- Vulnerable to noise and in particular to retriggering



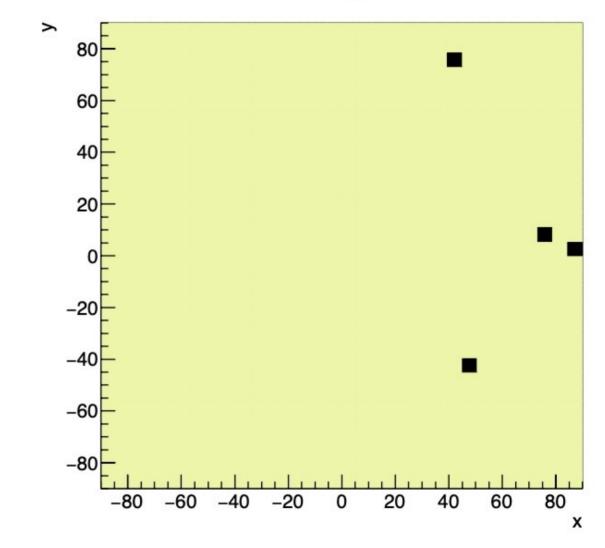
Impression Commissioning II







- Masked channels after lowering threshold to 275 DAC (~3/4 MIP)
- Short acquisition window 1ms
- Less vulnerable to noise and in particular to retriggering



- Masked channels after lowering threshold to 275 DAC (~3/4 MIP)
- Long acquisition window 100ms
- Vulnerable to noise and in particular to retriggering

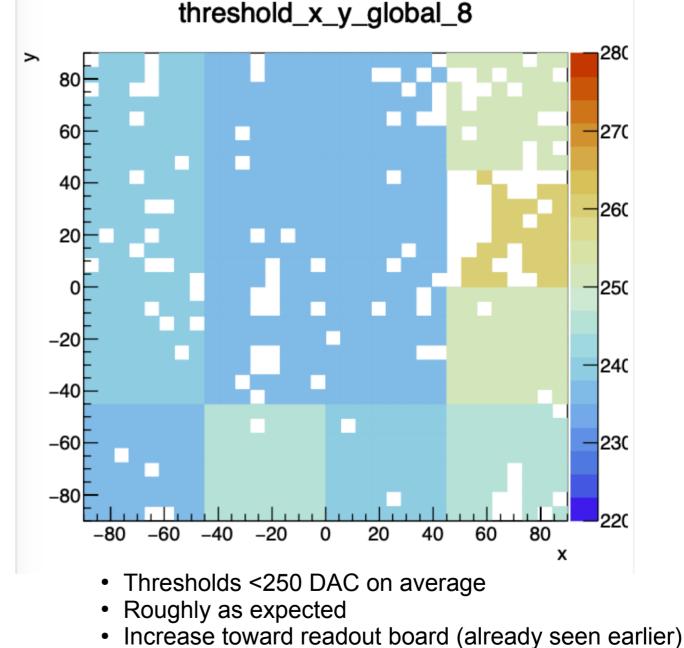


mask_x_y_SLB1

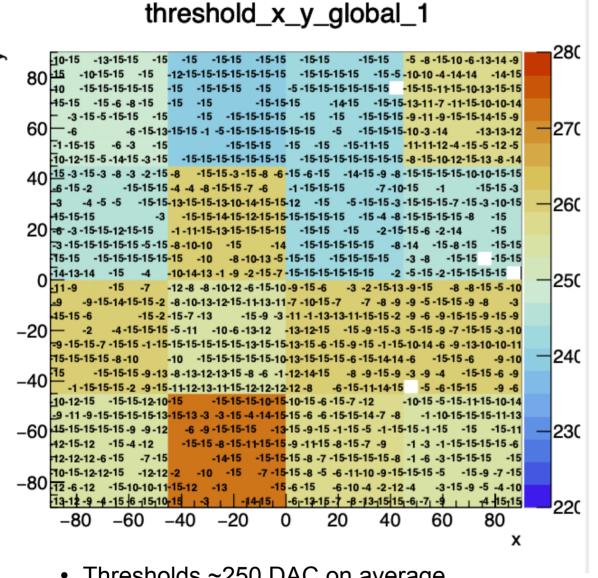
Impression Commissioning III – Thresholds for cosmics CALCO



SlabID 21 equipped with SK2



SlabID 30 equipped with SK2a => fine tuning possible

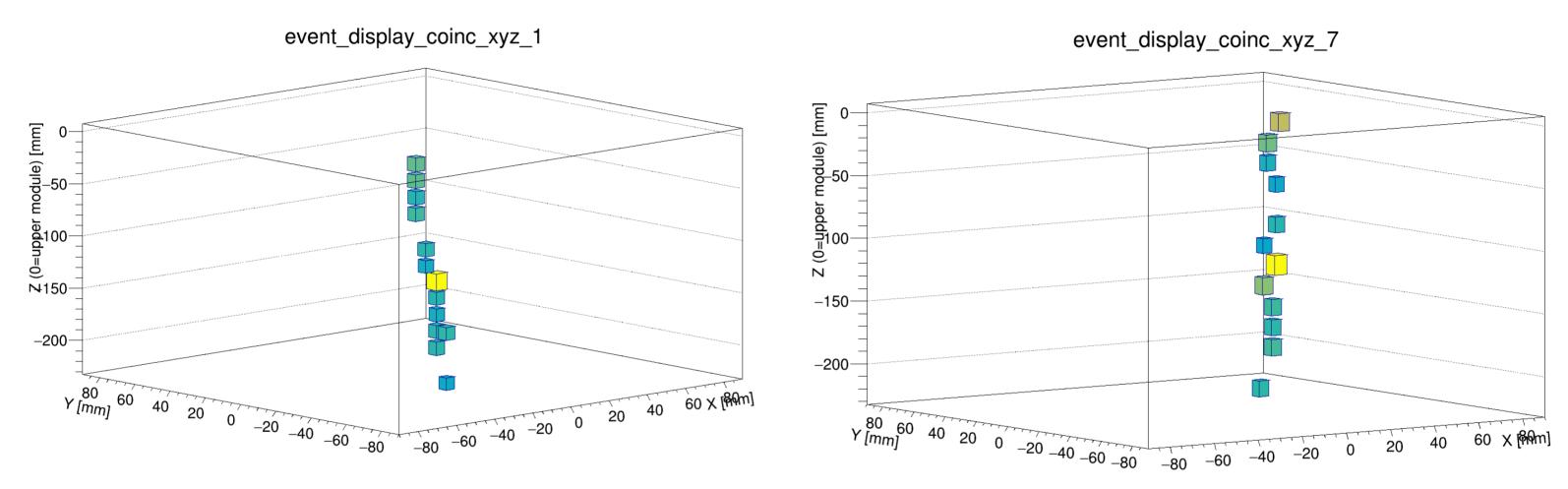


- Thresholds ~250 DAC on average
- On the high side but final interpretation after full analysis (new layer)





For entertainment – **Some cosmics**



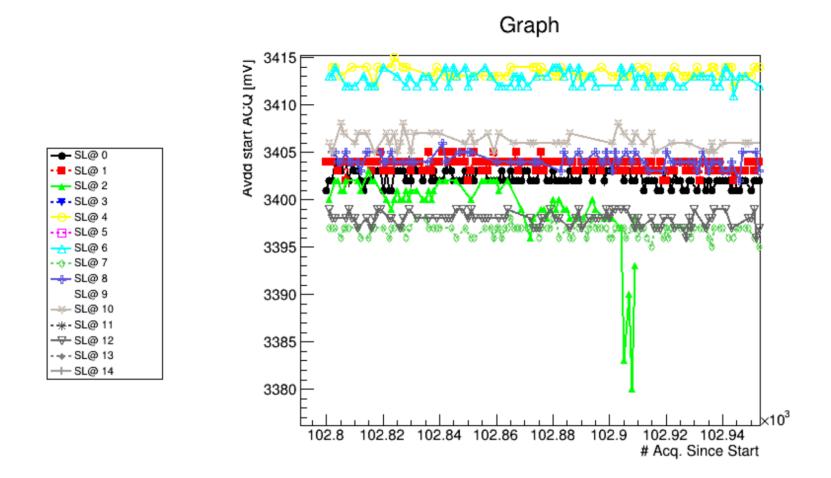
- Cosmics seen
- Next steps
 - More detailed analysis of cosmics
 - Refinement of masking procedure and threhold settings (where possible)
 - Hold scan
 - Gain intercalibration







The bad news ...



- One slab (ID13) died during cosmic run on 10/07/21 at 3am (!!!) CEST
- Slow control data show correlated voltage drop
 - Also HV power supply in weird state on Monday morning
 - 2A Fuse on SL Board got blown
 - First debugging revealed short cut between AVDD and GND on ASU
 - Reason (still) unknown





- Two FEV COBs delivered to CERN Bond lab for ASIC Boding on 1/7/21 (expect back next week)
 - For these two we have a metrology sheet and can thus follow the occurance of deformations
 - Expect back next week
 - These are supposed to go into the stack and replace some layers (if quality is satisfactory)
 - Decision during september
- Setup can also be completed by FEV13
- Conclusion, if Slab ID 13 is really damaged we have means to complete the stack
 - However, will try to identify root cause of damage and nature of damage
 - Hopefully the accident will teach us some lesson
- at least, setup of proper interlock and slow control systems for beam test





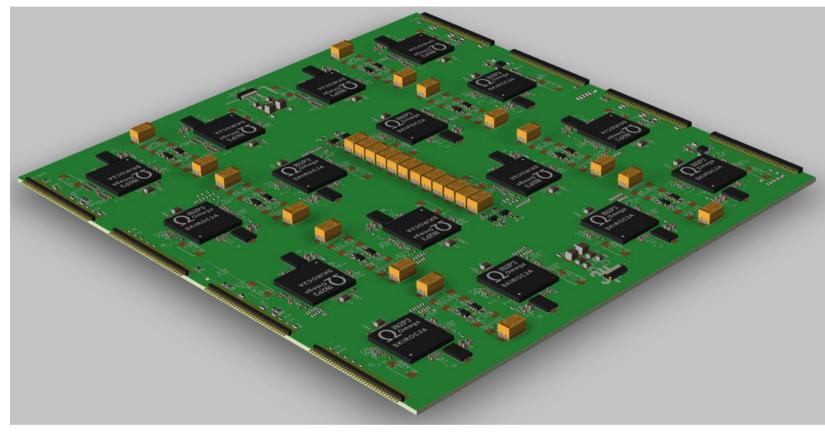
- SiECAL slot 1/11/21 15/11/21 just after l'AHCAL (if Covid-19 will permit:-()
 - Rough planning is 1.5 weeks of standalone data taking
 - Exercising of common data taking in remaining 0.5 weeks
 - N.B.: First survey revealed that IJCLab engineers will not be able in the week of 25/10/21 (during AHCAL running)
- Survey for presence at beam test will be launched soon
- Will also regularly review s/w status

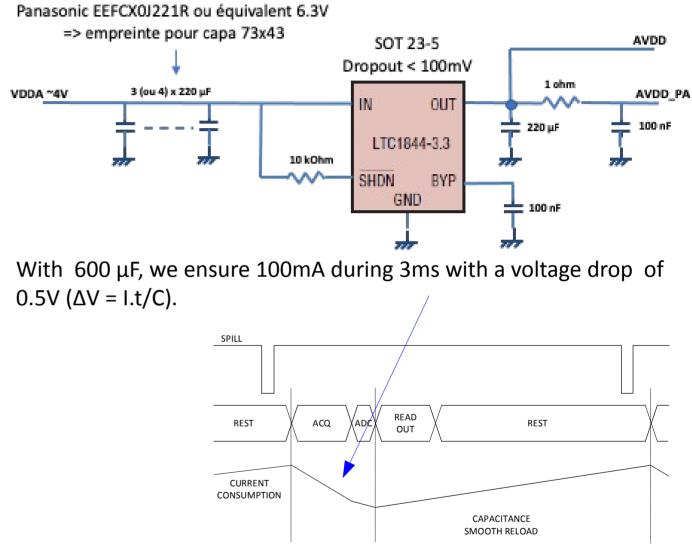


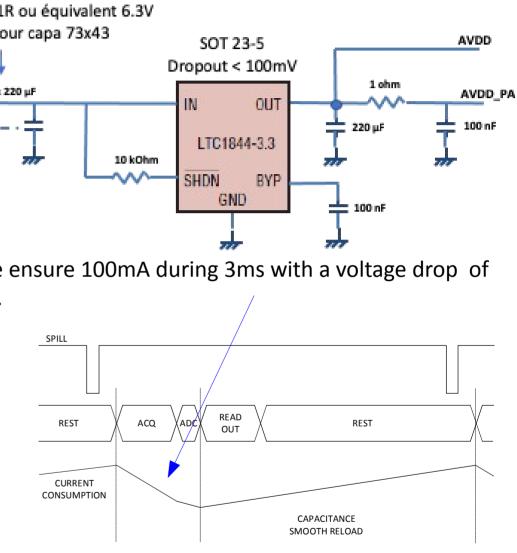
New FEV2.0 et al.



Status after regular discussions between engineers of LLR, IJCLab, LPNHE and OMEGA







- New board for next step of technical realisation of power pulsed Ecal layers
 - Capacitances and LDO close to ASICs
- Last month progress in design
 - Stacking of PCB
 - Choice of components
- Another important feature is that HV will be transported via connectors (i.e. On top of board
 - Wafer supply from bottom of board via plies (copper/kapton)
 - These plies are a delicate piece
 - Risk of shortcuts and wafer damage (the design of the kapton that goes below the board requires another design round)
- Expect production either shortly before or shortly after the summer break (not in a hurry, carefulness comes before speed)
- The setup will be completed by a "Termination card" that will allow for flexible chaining of cards (i.e. No soldering of terminations)
- and for flexible adding of decoupling capacitances (to study noise behaviour of COBs) Roman Pöschl CALICE TB Meeting July 2021





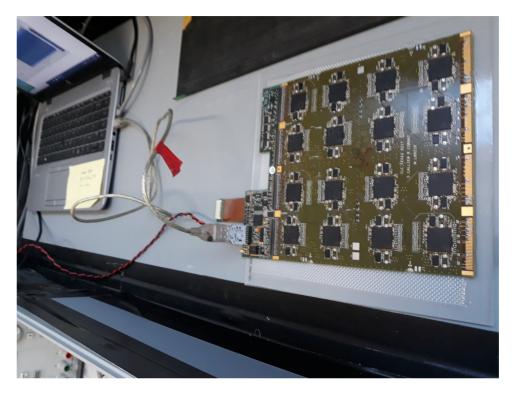
Backup





Interface to FEV13 and Deployment of hardware





FEV13 connected via interface card to SL-Board

New FEV12 on single slab test bench

- Interface card for allows for integration of FEV13 in stack
 - Successful technical tests in Autumn 2020
 - In total 7 FEV13 equipped with wafers are available in F and JP
- Started to deploy Hardware/software for digital readout (i.e. SL-Board and User Interface) to other Ecal groups
 - First "client" LLR
 - IFIC will follow during visit of Adrian end of May/June, as soon as travel will be possible
 - In preparation of deployment to Japan is planned







Status of Slabs – FEV10/11/12 + COBs

	DESY 2017		CERN 2018		
SLAB	status	calibrated cells	status	calibrated cells	Comments and 2021 status
13		0%		0%	Glue spilled in the SMBv. Recovered for 2020, Short cut 10/07/21
14		0%		0%	Error in the SR return \rightarrow fixed
15		0%		0%	Stopped working during the 2017 commissioning. recovered for 2021
16		92%		?	Delaminated wafer, repaired at LPNHE in 2021
17		93%		95%	Delaminated wafer, repaired at LPNHE in 2021
18		94%		?	At CERN : a pattern of lower MIP values is seen in the center of the ASU.
19		93%		93%	
20		94%		96%	
21		54%		0%	Stopped working at DESY 2018. Fully recovered for 2021
22		84%		87%	
23		0%		0%	FEV10 Never used \rightarrow operational now.
24					FEV12 (Summer 2019)
25					FEV12 (Summer 2019)
26					Damaged COB with only one wafer
27					Damaged COB with only one wafer
28					COB : One Chip broken, operational and ready for gluing but bent
29					COB : Operational and ready for gluing but bent
30					FEV12 freshly produced in Autumn/Winter 2020/21
31					FEV12 freshly produced in Autumn/Winter 2020/21

Slabs < Slab24 are FEV10 or FEV11







15 Slabs setup 02/06/21

coreKapton slot	Layer position	Slab ID	ASU type	wafer	front end (slboard ID)	Glissiere neded for the W	W in front (mm)	XO	X0 (acc)	Comments/
14	0	31	FEV12	500						
shot 13	1	30	FEV12	500						
12	2	13	FEV11	320	10	2.1mm	2.1	0.6	0.6	
11	3	14	FEV11	320	5	2.1mm	2.1	0.6	1.2	
10		15	FEV10	320	1	2.1mm	2.1	0.6	1.8	
9	5	19	FEV11	320	13	2.1mm	2.1	0.6	2.4	
8	6	20	FEV11	320	11	2.1mm	2.1	0.6	3	
7	7	24	FEV12	500	7	2.1mm	2.1	0.6	3.6	Stable AVDD
6	8	21	FEV11	320	14	2.1mm	2.1	0.6	4.2	
5	9	25	FEV12	500	3	2.1mm	2.1	0.6	4.8	problems co
4	10	22	FEV11	320	4	4.2mm	2.1	0.6	5.4	2008 B. B. B. B. B. B.
3	11	23	FEV10	320	6	4.2mm	4.2	1.2	6.6	
2	12	16	FEV11	320	9	2.1mm	2.1	0.6	7.2	
1	13	17	FEV11	320	2	4.2mm	4.2	1.2	8.4	problems co Stable consu
0	14		FEV11	320		whatever (no W will be added				



s/Issues	
DD ??	
communicating the ID of the SLboard ?? (SOLVED)	
가는 바람 가슴은 가슴	

communicating the ID of the SLboard ?? (SOLVED) sumption ?? -> SOLVED shorcut in DVDD (capacitance in skiroc 14)